

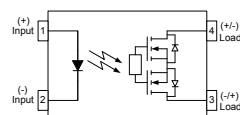
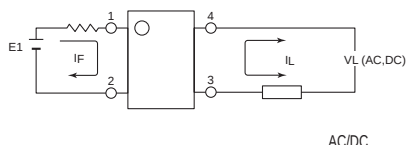
Parameter	Symbol	Rating	Units
Load Voltage	V_L	60	V
Load Current	I_L	2	A
On-Resistance	R_{on}	0.069	Ω
I/O Isolation Voltage	V_{io}	5000	V_{rms}



DIP-4



SMD-4



1. LED Anode
2. LED Cathode
- 3.4. Drain(MOS FET)

SUPSiC PhotoRelays

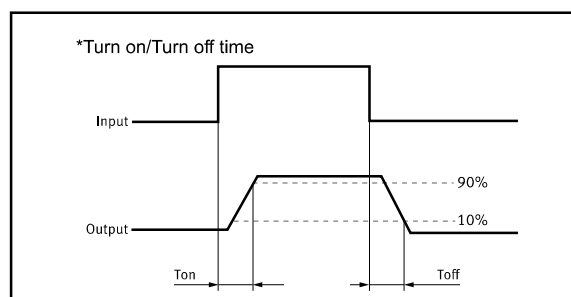
- Long life (No limit on mechanical and electrical lifetime) Bounce-free switching
- Higher speed and high frequency switching
- Higher sensitivity (less power consumption)
- Immunity to EMI or RFI
- No have voltaic arc, bounce, and noise More
- resistant to vibration and impact AC or DC load
- switching
- Small package size

Applications

- Telecom/Datacom switching
- Multiplexers
- Meter reading systems
- Data acquisition
- Medical equipment
- Battery monitoring
- I/O Sub-Systems
- Robotics
- Aerospace
- Home/Safety security systems
- Process Control
- Energy Management
- Reed Relay EMR Replacement
- Programmable Controllers

TPYES

Category	Output rating		Package	Part No.	Packing quantity
	Load voltage	Load current			
AC/DC	60V	2A	DIP4	GAQY212G2E	100pcs/tube
			SMD4	GAQY212G2EH	2000pcs/1reel



Absolute Maximum Ratings (Ta = 25°C)

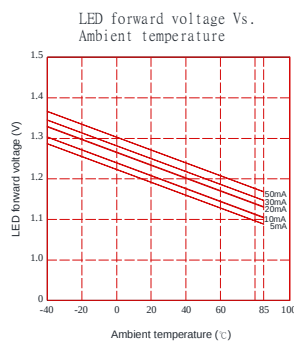
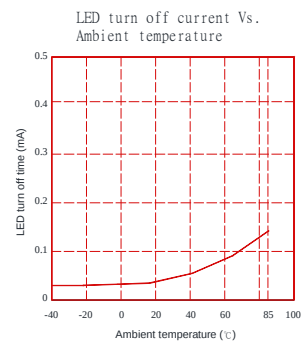
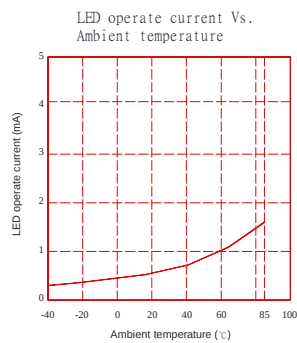
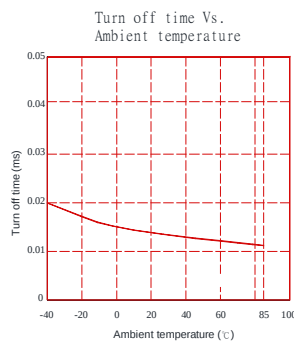
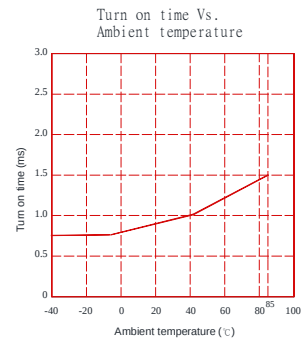
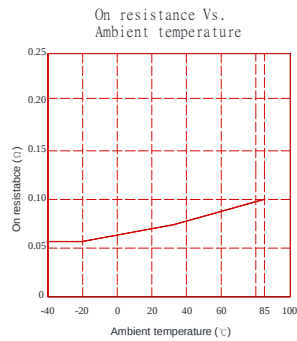
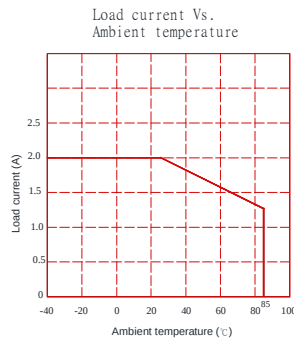
	Item	Symbol	Value	Units	Note
Input	Continuous LED Current	I _F	50	mA	
	Peak LED Current	I _{FP}	1000	mA	f=100Hz, duty=1%
	LED Reverse Voltage	V _R	5	V	
	Input Power Dissipation	P _{In}	75	mW	
Output	Load Voltage	V _L	60	V(AC peak or DC)	
	Load Current	I _L	2.0	A	
	Peak Load Current	I _{Peak}	6.0	A	100ms(1 pulse)
	Output Power Dissipation	P _{out}	500	mW	
Total Power Dissipation		P _T	650	mW	
I/O Isolation Voltage		V _{I/O}	5000	V _{rms}	RH=60%, 1min
Operating Temperature		T _{opr}	-40 to +85	°C	
Storage Temperature		T _{stg}	-40 to +100	°C	
Pin Soldering Temperature		T _{sol}	260	°C	10 sec max.

Electrical Specifications (Ambient Temperature: 25°C)

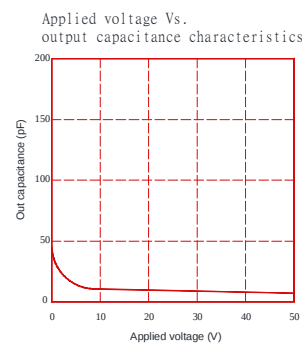
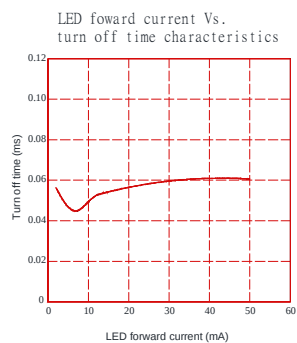
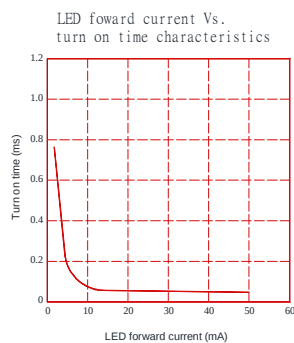
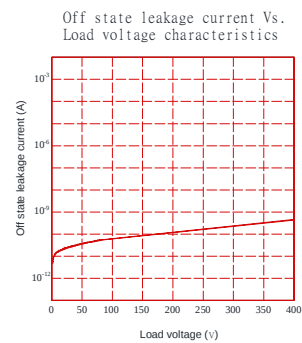
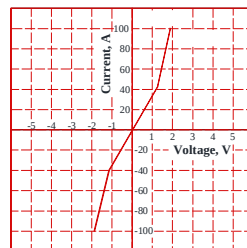
	Item	Symbol	MIN.	TYP.	MAX.	Units	Conditions
Input	LED Forward Voltage	V _F	1.2	1.32	1.6	V	I _F =10mA
	Operation LED Current	I _{F on}		1.0	5.0	mA	
	Recovery LED Current	I _{F off}		0.35	0.5	mA	
	Recovery LED Voltage	V _{F off}	0.7			V	
Output	On-Resistance	R _{on}		0.069	0.12	Ω	I _F =5mA, I _L =Max Time to flow is within 1 sec.
	Off-State Leakage Current	I _{Leak}		0.1		uA	V _L =Rating
	Output Capacitance	C _{out}		115		pF	V _L =0, f=1MHz
Transmis sion	Turn-On Time	T _{on}	1.0	2.7	3.2	ms	I _F =5mA, I _L =Max
	Turn-Off Time	T _{off}	0.04	0.05	0.1	ms	
Coupled	I/O Isolation Resistance	R _{I/O}	5			GΩ	DC500V
	I/O Capacitance	C _{I/O}		0.8	1.5	pF	f=1MHz

Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value): I_F ≥5mA and ≤30mA

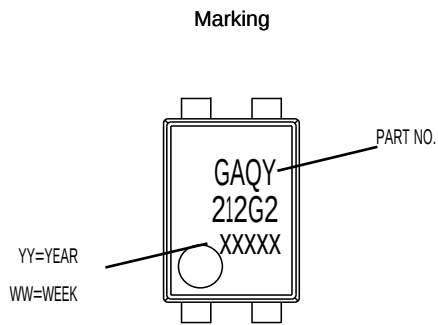
Engineering Data



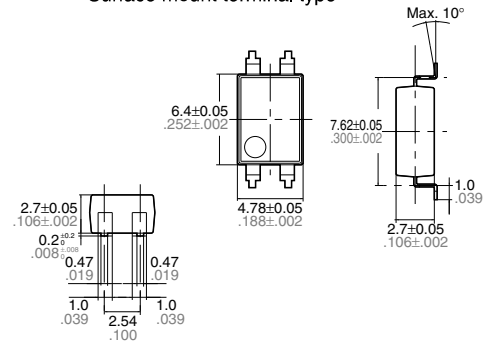
Voltage Vs. current characteristics
of output at MOS portion



Dimensions and SMD-4 Package Unit: mm

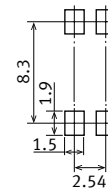


Surface mount terminal type



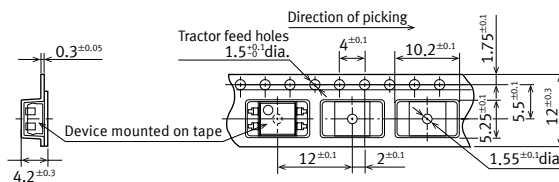
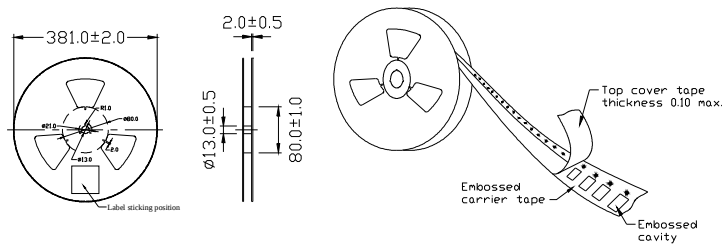
Terminal thickness: $t = 0.2$
General tolerance: ± 0.1

Recommended mounting pad (TOP VIEW)



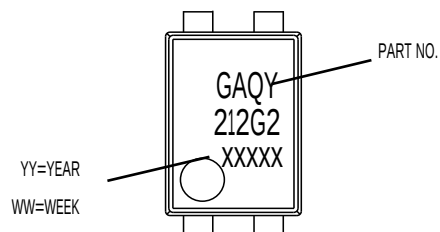
Tolerance: ± 0.1

Tape dimensions (tape reel)

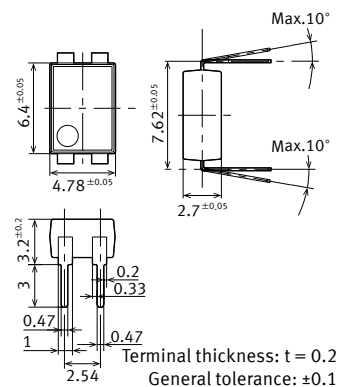


Dimensions and DIP-4 Package Unit: mm

Marking

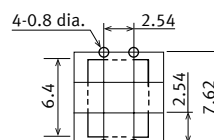


Surface mount terminal type



PC board pattern

(BOTTOM VIEW)

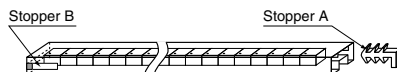


Tolerance: ± 0.1

Tape dimensions (tape reel)

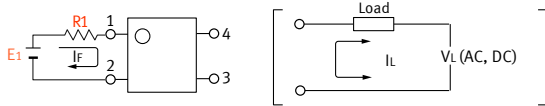
DIP type

Devices are packaged in a tube so that pin No. 1 is on the stopper B side. Observe correct orientation when mounting them on PC boards.



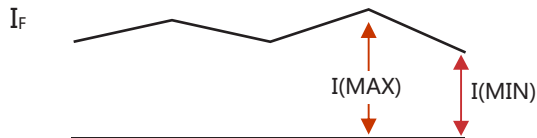
Using Methods

Examples of resistance value to control LED forward current ($I_F=5\text{mA}$)



E1	R1 (Approx)
3.3V	300 Ω
5.0V	600 Ω
12V	1.9K Ω
24V	4.1K Ω

LED forward current must be more than 5mA , at $I(\text{MIN})$,and less than 30mA , at $I(\text{MAX})$.



Recommended Operating Conditions

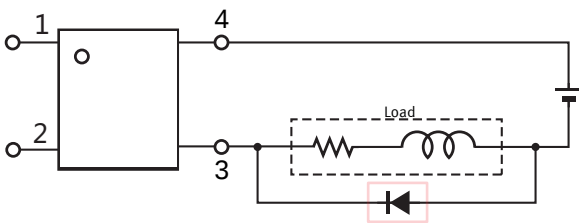
Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value):

Characteristic	Symbol	Min	Typ.	Max	Unit
Forward current	I_F	5.0	7.0	30	mA

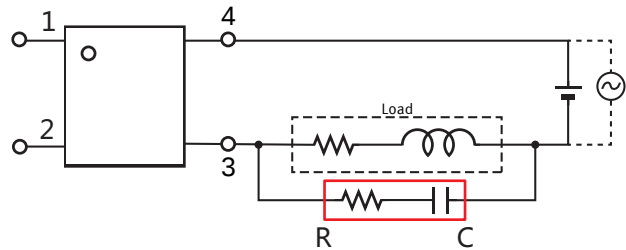
Protection Circuit

Output spike voltages:if an inductive load generates spike voltages which exceed heabsolute maximum rating, the spike voltage shall be limited.

Clamp diode is connected in parallel with the load.
Absorb capacity with external diode.



CR Snubber is connected in parallel with the load.
Absorb capacity with buffer capacity.



When adding diodes, buffer circuits (C-R), and other protections, they need to be installed near the MOS RELAY to be effective.
Adding protection elements may result in a slow reset time, so adjust them according to the actual situation before use.

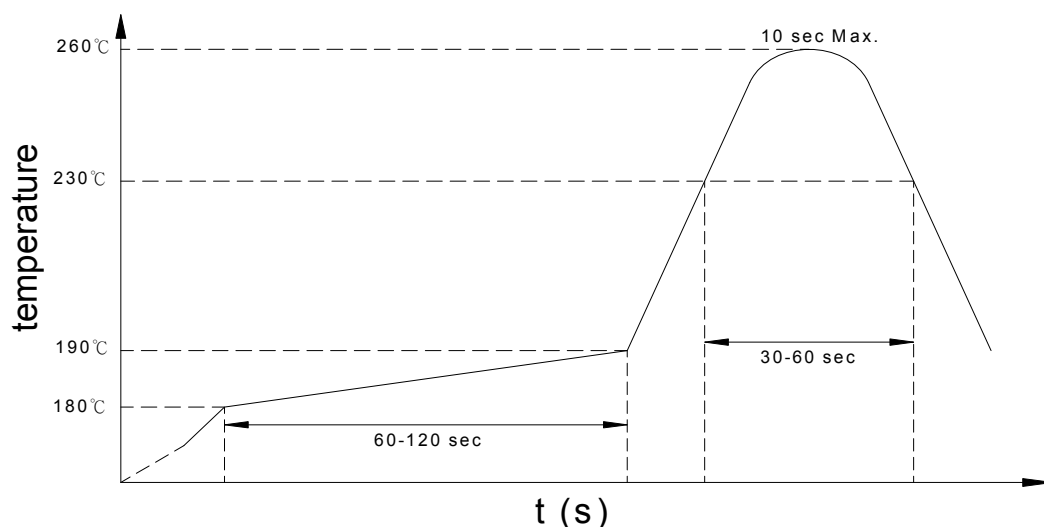
Note: When developing designs using this product, perform the expected performance of the equipment under the operating conditions recommended by the guidelines in this document. Continuous use under heavy loads (including, but not limited to, the application of high temperatures/current/voltage and significant changes in temperature, etc.) may result in deterioration of the reliability of this product.

Recommended Soldering Conditions

(a) Infrared reflow soldering :

- Peak reflow soldering : 260°C or below (package surface temperature)
- Time of peak reflow temperature : 10 sec
- Time of temperature higher than 230°C : 30-60 sec
- Time to preheat temperature from 180~190°C : 60-120 sec
- Time(s) of reflow : Two
- Flux : Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



(b) Wave soldering :

- Temperature : 260°C or below (molten solder temperature)
- Time : 10 seconds or less
- Preheating conditions : 120°C or below (package surface temperature)
- Time(s) of reflow : One
- Flux : Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(c) Cautions :

- Fluxes : Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.
- Avoid shorting between portion of frame and leads.